

L Number	Hits	Search Text	DB	Time stamp
1	696	(al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 19:11
2	575	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 18:54
3	570	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)) and (heat\$4 or temperature)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 18:54
4	320	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)) and (heat\$4 or temperature)) and (inert or nitrogen or argon or helium or gas) near (heat\$4 or temperature or oven or atmosphere or environment)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 18:54
5	12	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)) and (heat\$4 or temperature)) and (inert or nitrogen or argon or helium or gas) near (heat\$4 or temperature or oven or atmosphere or environment)) and peel near strength	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 19:11
6	173	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)) and (heat\$4 or temperature)) and (inert or nitrogen or argon or helium or gas) near (heat\$4 or temperature or oven or atmosphere or environment)) and (al or aluminum) near (pure or purity)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 19:11
7	11	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)) and (heat\$4 or temperature)) and (inert or nitrogen or argon or helium or gas) near (heat\$4 or temperature or oven or atmosphere or environment)) and (al or aluminum) near (pure or purity)) and peel near strength	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 19:12
8	3	((al or aluminum) near (pure or purity or "%" or percent\$4) and ceramic and (al or aluminum or ceramic) near (bond\$4 or join\$4 or weld\$4 or solder\$4 or braz\$4)) and (inert or nitrogen or argon or helium or gas)) and (heat\$4 or temperature)) and (inert or nitrogen or argon or helium or gas) near (heat\$4 or temperature or oven or atmosphere or environment)) and (al or aluminum) near (pure or purity)) and peel near strength and power adj module	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/08 19:12